

# P-Channel 30-V (D-S) MOSFET

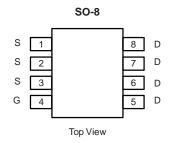
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
- 30	0.018 at V <sub>GS</sub> = - 10 V	- 9.0	13 nC			
- 30	0.024 at V <sub>GS</sub> = - 4.5 V	- 7.8	13110			

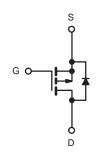
#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % Rg Tested

### **APPLICATIONS**

- Load Switch
- Battery Switch





P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25 \text{ °C}$ , unless otherwise noted						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V <sub>DS</sub>	- 30	V			
Gate-Source Voltage	V <sub>GS</sub>	± 20	V			
	T <sub>C</sub> = 25 °C		- 9.0			
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C		- 7.2			
Continuous Drain Current $(1) = 150^{\circ}$ C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 7.0 <sup>a, b</sup>			
	T <sub>A</sub> = 70 °C	1	- 5.6 <sup>a, b</sup>	A		
Pulsed Drain Current	I <sub>DM</sub> - 30	- 30				
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	L.	- 3.5			
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 2.1 <sup>a, b</sup>			
	T <sub>C</sub> = 25 °C		4.2			
Movimum Dower Dissinction	T <sub>C</sub> = 70 °C		2.7	w		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	vv		
	T <sub>A</sub> = 70 °C	1 [	1.6 <sup>a, b</sup>			
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	40	50	°C/W	
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	24	30	0/11	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 95 °C/W.

d. Based on  $T_C = 25$  °C.



Available

<b>SPECIFICATIONS</b> $T_J = 25 \circ C$			1	1	1	
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 31		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			4.5		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 2.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 1 - 5	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 20			А
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -7.0 \text{ A}$ $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -5.6 \text{ A}$		0.018		Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 7.0 A		18		S
Dynamic <sup>b</sup>	010		I			I
Input Capacitance	C <sub>iss</sub>	[		1455		1
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		180		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			145		
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 7.0 A		25	38	-
	, , , , , , , , , , , , , , , , , , ,		13	20	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -7.0 \text{ A}$		3.5		4
Gate-Drain Charge	Q <sub>gd</sub>	<i></i>		5.5		
Gate Resistance	Rg	f = 1 MHz	0.4	2.0	4.0	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			10	20	
Rise Time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, \text{ R}_{L} = 2.7 \Omega$		13	20	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 5.6 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		23	35	_
Fall Time	t <sub>f</sub>			9	18	ns
Turn-On Delay Time	t <sub>d(on)</sub>			38	57	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, R <sub>L</sub> = 2.7 $\Omega$		89	134	_
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_{D}\cong$ - 5.6 A, $V_{GEN}$ = - 4.5 V, $R_{g}$ = 1 $\Omega$		22	33	
Fall Time	t <sub>f</sub>			11	17	
Drain-Source Body Diode Characteris	stics		-			_
Continous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 6.5	A
Pulse Diode Forward Current	I <sub>SM</sub>				- 30	А
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 5.6 A, V <sub>GS</sub> = 0 V		- 0.71	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			22	33	ns
Body Diode Reverse Recovery Charge	Body Diode Reverse Recovery Charge O			17	26	nC
Reverse Recovery Fall Time	ta	I <sub>F</sub> = - 5.6 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		13		
Reverse Recovery Rise Time	t <sub>b</sub>			9		ns

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

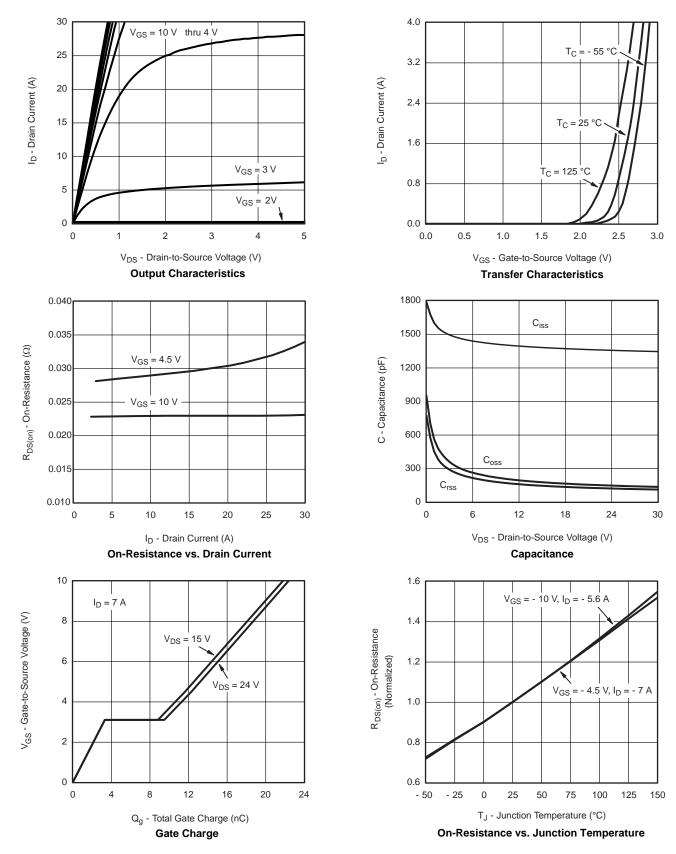
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

emi

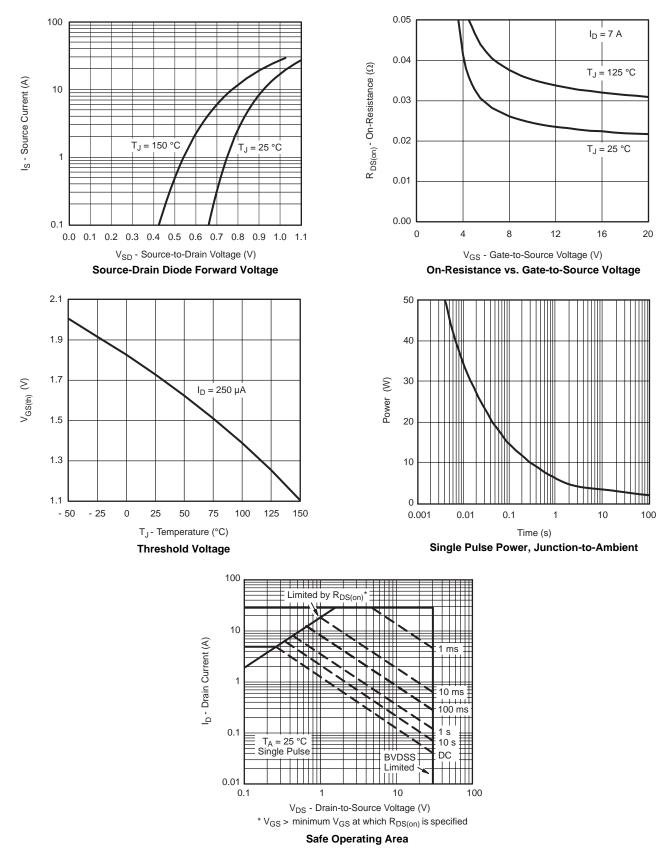






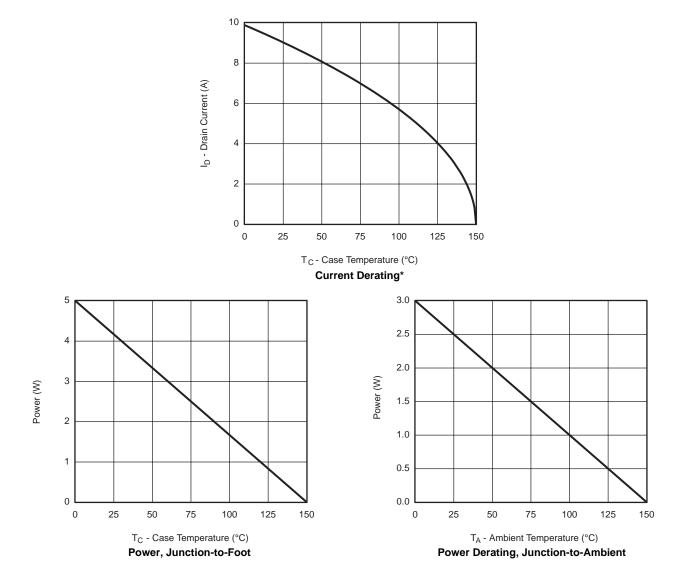


## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





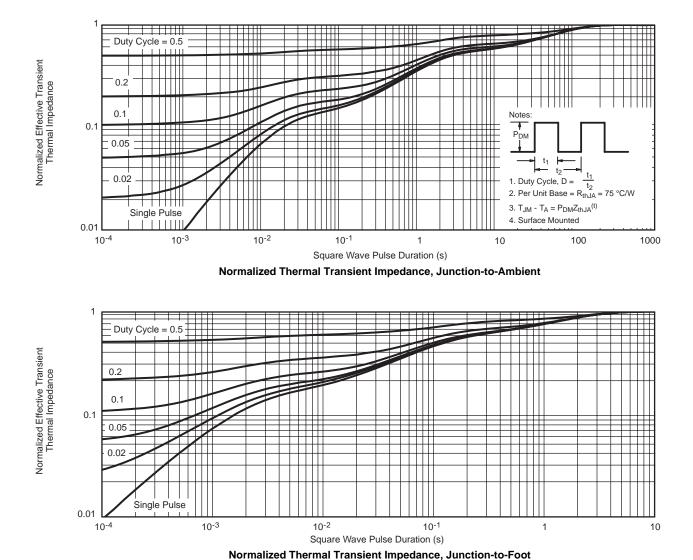
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

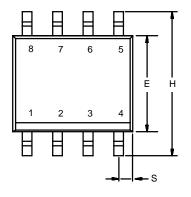






## SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

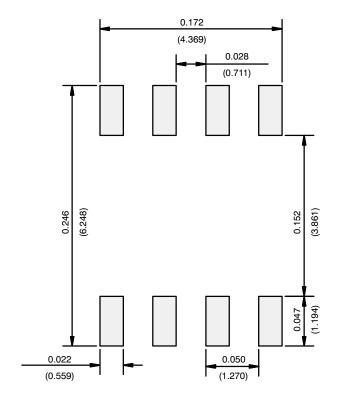




	MILLIM	IETERS	INCHES		
DIM	Min	Max	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)



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